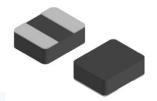
FEATURES

- Metal material for large current and low loss.
- Ultra low buzz noise.
- Metal material for large current and low loss.
- Olosed magnetic circuit design reduces leakage.

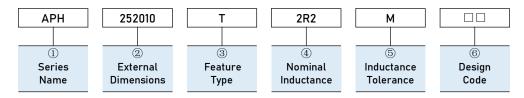


APPLICATIONS

- Smart phone, set top box, VR, AR
- SSD, Bluetooth, Wi-Fi module
- Laptops and PCs
- Base stations
- RoHS, REACH Compliance.

PART NUMBERING

③Feature Type



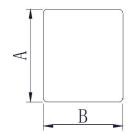
① Series Name						
APH	Molded SMD Power Inductors					

②External Dimensions(L×W×H) [mm]					
201208 2.0x1.2x0.8					
201610	2.0x1.6x1.0				
252010	2.5x2.0x1.0				
252012	2.5x2.0x1.2				

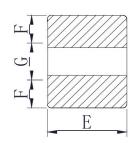
C. Cata. C., p	©. •=· · , p •							
Т	Standard							
4 Nominal ind	4 Nominal inductance							
Code	Nominal inductance [µH]							
(example)	Nominatinductance [µH]							
R47	0.47							
2R2	2.2							
4R7	4.7							

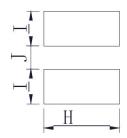
⑤Inductance tolerance							
Code (example)	Inductance tolerance						
М	±20%						
6 Design Code							
	Standard product is blank						

DIMENSIONS & RECOMMENDED LAND PATTERN









Recommended Land Pattern

Unit: mm

	Dimensions								d Pattern
Series	Α	В	C Max.	Е Тур.	F Typ.	G Typ.	Н Тур.	l Typ.	JTyp.
APH201208	2.0±0.2	1.2±0.2	0.80	1.2	0.8	0.5	1.4	0.9	0.5
APH201610	2.0±0.2	1.6±0.2	1.00	1.6	0.7	0.6	1.8	0.9	0.5
APH252010	2.5±0.2	2.0±0.2	1.00	2	0.9	0.7	2.1	1.0	0.6
APH252012	2.5±0.2	2.0±0.2	1.20	2	0.9	0.7	2.1	1.0	0.6

ELECTRICAL CHARACTERISTICS

●APH201208 Series

Part Number	Inductance	Inductance Tolerance	Saturation Current	Heat Rating Current	D Resis	C tance			
	@100	kHz,1V	Max.	Max.	Max.	Тур.			
Units	μH	-	Α	Α	mΩ				
Symbol	L	-	Isat	Irms	DCR				
APH201208TR47M	0.47	±20%	4.60	2.70	50	34			
APH201208T1R0M	1	±20%	3.50	2.40	70 55				
APH201208T2R2M	2.2	±20%	2.30	1.50	185	160			

● APH201610 Series

Part Number	Inductance	Inductance Tolerance	Saturation Current	Heat Rating Current	_	C tance
	@100	lkHz,1V	Max.	Max.	Max.	Тур.
Units	μН	-	А	Α	m	Ω
Symbol	L	-	Isat	Irms	DO	CR
APH201610TR22M	0.22	±20%	6.30	5.80	22	16
APH201610TR24M	0.24	±20%	6.30	5.80	22	16
APH201610TR33M	0.33	±20%	6.20	5.30	24	19
APH201610TR47M	0.47	±20%	6.00	5.60	28	22
APH201610TR68M	0.68	±20%	5.50	5.00	34	24
APH201610T1R0M	1	±20%	4.20	4.10	43	38
APH201610T1R5M	1.5	±20%	2.90	2.30	100	90
APH201610T2R2M	2.2	±20%	2.80	2.10	150	135
APH201610T3R3M	3.3	±20%	2.00	1.50	180	162
APH201610T4R7M	4.7	±20%	1.50	1.15	250	229



ELECTRICAL CHARACTERISTICS

●APH252010 Series

Part Number	Inductance	Inductance Tolerance	Saturation Current	Heat Rating Current	D Resis	_
	@100	lkHz,1V	Max.	Max.	Max.	Тур.
Units	μН	-	Α	Α	m	Ω
Symbol	L	-	Isat	Irms	DO	CR
APH252010TR24M	0.24	±20%	7.80	6.40	21	15.5
APH252010TR33M	0.33	±20%	7.20	6.20	22	16
APH252010TR47M	0.47	±20%	6.50	5.60	23	17
APH252010TR68M	0.68	±20%	5.50	5.00	29	22
APH252010T1R0M	1	±20%	4.80	4.10	33	25
APH252010T1R5M	1.5	±20%	3.90	3.00	55	42
APH252010T2R2M	2.2	±20%	3.00	2.10	70	62
APH252010T3R3M	3.3	±20%	2.50	2.00	100	86
APH252010T4R7M	4.7	±20%	2.00	1.60	160	145

●APH252012 Series

Part Number	Inductance	Inductance Tolerance	Saturation Current	Heat Rating Current	D Resis		
	@100	kHz,1V	Max.	Max.	Max.	Тур.	
Units	μН	-	Α	Α	m	mΩ	
Symbol	L	-	Isat	Irms	DO	CR	
APH252012T1R0M	1	±20%	4.30	3.30	42	38	
APH252012T2R2M	2.2	±20%	3.30	2.20	75	64	

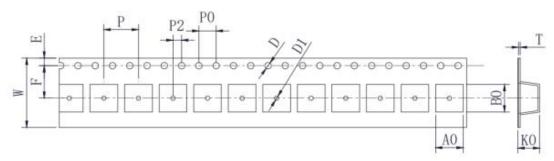
RELIABILITY DATA

Items	Requirements	Test Methods and Remarks
Insulation Resistance	≥100MΩ	100 V DC between inductor coil and The middle of the top surface of the body for 60 seconds.
Solderability	90% or more of electrode area shall be coated by new solder.	Dip pads in flux and dip in solder pot (96.5Sn/3.0Ag/0.5Cu) at (245±5) [°] C for (5±1) seconds.
Resistance to Soldering Heat	No visible mechanical damage. Inductance change: Within ±10%	Dip pads in flux and dip in solder pot (96.5Sn/3.0Ag/0.5Cu) at (260±5) [°] C for (10±1) seconds.
Adhesion of terminal electrode	Strong bond between the pad and the core, without come off PC board.	Inductors shall be subjected to $(260\pm5)^{\circ}$ C for (20 ± 5) s Soldering in the base whit 0.3mm solder. And then aplomb electrode way plus tax 10 N for (10 ± 1) seconds.
High temperature	No visible mechanical damage. Inductance change: Within ±10%	Temperature is (+85±2)℃ and keep (96±2) hours.
Low temperature	No visible mechanical damage. Inductance change: Within ±10%	Temperature is (-40±2) [°] C and keep (96±2) hours.
Thermal shock	No visible mechanical damage. Inductance change: Within ±10%	The test sample shall be placed at $(-40\pm3)^{\circ}\mathbb{C}$ and $(125\pm2)^{\circ}\mathbb{C}$ for (30 ± 3) min, different temperature conversion time is 2~3 minutes. The temperature cycle shall be repeated 32 cycles. Placed at room temperature for 2 hours, within 48 hours of testing.
Temperature characteristic	Inductance change P_{c-b} , P_{c-d} . Within ±20%	a: $+20 ^{\circ}\mathbb{C}$ (30~45) min \rightarrow b: $-40 ^{\circ}\mathbb{C}$ (30~45) min \rightarrow c: $+20 ^{\circ}\mathbb{C}$ (30~45) min \rightarrow d: $+125 ^{\circ}\mathbb{C}$ (30~45) min \rightarrow e: $+20 ^{\circ}\mathbb{C}$ (30~45) min Pc-b = Lb - Lc '100%; Pc-d = Ld - Lc '100% Lc Lc
Static Humidity	No visible mechanical damage. Inductance change: Within ±10%	Inductors shall be subjected to (93±3)%RH . at (60±2)°C for (96±2) h . Placed at room temperature for 2 hours, within 48 hours of testing.
Life	No visible mechanical damage. Inductance change: Within ±10%	Inductors shall be store at (85±2) [°] C for (1000±24) hours with Irms applied. Placed at room temperature for 2 hours, within 48 hours of testing.



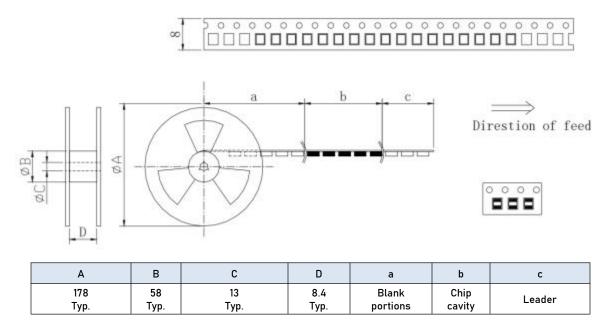
PACKAGE

Tape Dimension (Unit:mm)



W	A0	В0	D	D1	E	F	K0	P0	P2	Р	Т
8±0.3	2.2±0.1	2.7±0.1	1.5±0.1	1.0MIN	1.75±0.1	3.5±0.1	1.15±0.1	4.0±0.3	2.0±0.3	4.0±0.3	0.25±0.05

Direction of feed (Unit:mm)



Packing quantity

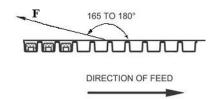
Reel(PCS)	Box (PCS)	Carton (PCS)
3000	15000	150000

Peeling required

Fforce: $10\sim130g$;

Peeling speed: 300mm/min±10%;

Peeling angle: $165^{\circ} \sim 180^{\circ}$.





RECOMMENDED SOLDERING PROFILE

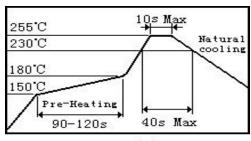
Applicable soldering process to the products is reflow soldering.

Soldering Materials

(1)Solder: Sn-3.0Ag-0.5Cu

(2)Flux: Use rosin-based flux, but not strongly acidic flux (with chlorine exceeding 0.2 wt%). Do not use water-soluble flux.

Soldering Profile



Time(s)

Soldering Iron

Reworking with electric soldering iron must preheating at 150° C for 1 minute is required, and do not directly touch the core with the tip of the soldering iron. The reworking soldering conditions are as follows:

*Temperature of soldering iron tip: 350°C;

*Soldering iron power output: ≤30W;

*Diameter of soldering iron end: ≤1.0mm;

*Soldering time: <3s

CLEANING

*The following conditions should be observed when cleaning the products:

*Cleaning Temperature: 60 °C max. (40 °C max. for alcohol cleaning agents)

Ultrasonic:

Output: 20 W/L max. Duration: 5 min max. Frequency: 28 to 40kHz

Avoid the resonance between PCB and mounted products when it is cleaning.



Storage Methods

Storage Period

To maintain the solderability of terminal electrodes and to keep the packing material in good condition, product should be used within 6 months from the time of delivery. And the solderability of products electrodes may decrease as time passes, so in case of storage over 6 months, solderability shall be checked before actual usage.

Storage Conditions

Store products in a warehouse in compliance with the following condition:

(Temperature): Inductors (product with taping) -10 to +40 $^{\circ}\mathrm{C}$;

Inductors body -40 to +85 $^{\circ}$ C.

(Humidity): 30~70%RH.

*Do not store the products in chemical atmosphere such as one containing sulfurous acid gas or alkaline gas, that will causes poor solderability and corrosion of inductors.

*Do not store products in bulk packaging to prevent collision among inductors which causes core chipping and wire breakage.

*Store products on pallets to protect from humidity, dust, etc.

Precautions For Use

*Our products are designed and promoted for use in general electronic devices such as audio-equipment, office automation equipment, household appliance and information service.

*In case of using the product for the purpose other than general electronics devices, we shall not be held liable for any dysfunctions in or damage to the equipment with which the product is used.

*Our specification limits the quality of the component as a single unit. Please ensure the component is thoroughly evaluated in your application circuit.

*Do not apply excessive vibration or mechanical shock to products.

*Donot touch wire with sharp objects such as tweezers to prevent wire breakage.

*Do not apply excessive stress to products mounted on boards to prevent core breakage.

Note:

This series product is not applies in automotive or related products. Otherwise, we will shall not bear than the resulting all the problems of quality and responsibility.

Please be sure to request approval specifications that provide further details of the products. Kindly not that the content of these specifications are subject to change or may be discontinued without prior notice. This product may not be designed/used in medical or high risk applications without APV approval.



^{*}Do not subject products to rapid changes in temperature and humidity.

^{*}Avoid heat shock, vibration, direct sunlight, etc.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Fixed Inductors category:

Click to view products by APV manufacturer:

Other Similar products are found below:

CR32NP-100KC 70F224AI MHQ1005P10NJ MHQ1005P1N0S MHQ1005P2N4S MHQ1005P3N6S MHQ1005P5N1S MHQ1005P8N2J PE-53601NL PE-53602NL PG0936.113NLT 9220-20 9310-16 PM06-2N7 PM06-39NJ A01TK 1206CS-471XJ HC2-R47-R HC8-1R2-R HCF1305-3R3-R 1206CS-151XG RCH664NP-4R7M RCP1317NP-391L DH2280-4R7M DS1608C-106 B10TJ B82498B3101J000 ELJ-RE27NJF2 1812CS-153XJ 1812CS-183XJ 1812CS-223XJ 1812LS-104XJ 1812LS-105XJ 1812LS-124XJ 1812LS-154XJ 1812LS-223XJ 1812LS-223XJ 1812LS-224XJ 1812LS-563XJ 1812LS-683XJ 1812LS-824XJ NIN-FB101JTR110F NIN-FB471JTR62F NIN-FC1R5JTR220F NIN-HCR15JTRF NIN-HCR33JTRF NIN-HDR22JTRF NIN-HDR82JTRF NIN-HK2N7STRF NIN-PA150KTR370F NIN-PB100KTR550F